

## SC-TOSA 2.5G 1310nm MQW-DFB Laser Diode

### OSMS-TOSAXXXDX3

#### Features:

- ◆ Coaxial Package
- ◆ InGaAsP/InP MQW-DFB Laser Diode
- ◆ Low threshold, high slope efficiency and high output power LD
- ◆ Maximum Soldering Temperature /Time:260°C/10s
- ◆ Operating Case Temperature: -40°C to +85°C
- ◆ RoHS Compliant Products Available

#### Applications:

- ◆ CATV Analog Return Path Optical Transmitter
- ◆ GSM/CDMA Optical Repeater
- ◆ W-CDMA/CDMA2000/TD-SCDMA Optical Repeater
- ◆ Microwave Transmission System
- ◆ Test Equipments

#### General:

OSMS-TOSAXXXDX3X Series are 1310nm InGaAsP/InP MQW-DFB laser diode modules designed for fiber optic communication systems. These modules are transmitter optical sub-assembly with low threshold current and high performance at high temperature. Ideally suitable for short reach applications, data rates from 1.25G to 2.5G.

A laser diode is mounted into a  $\phi 5.6\text{mm}$  coaxial package integrated with an InGaAs monitor PD, a single -mode fiber-stub and a split sleeve for the optical connector with  $\phi 2.5\text{mm}$  ferrule.

#### Ordering Information: (Standard version <sup>\*Note1</sup>)

Part No.	Pin Type	LD Type	Power	Data Rate
OSMS-TOSA61BF013	LD-Pin-2	FP	01	1.25G
OSMS-TOSA52BF013	LD-Pin-2	FP	01	2.5G

\*Note1: For more ordering information, please refer the nomenclature and contact OSM sales.

**Absolute Maximum Ratings:** \*Note2

Parameter	Symbol	Ratings	Unit
Storage Temperature	Tstg	-40~+100	°C
Operating Case Temperature	Top	-40~+85	°C
Forward Current (LD)	IFD	150	mA
Reverse Voltage (LD)	VrL	2	V
Reverse Voltage (PD)	VrP	20	V
Reverse Current (PD)	IrP	2	mA
Soldering Temperature (<10s)	Stemp	260	°C

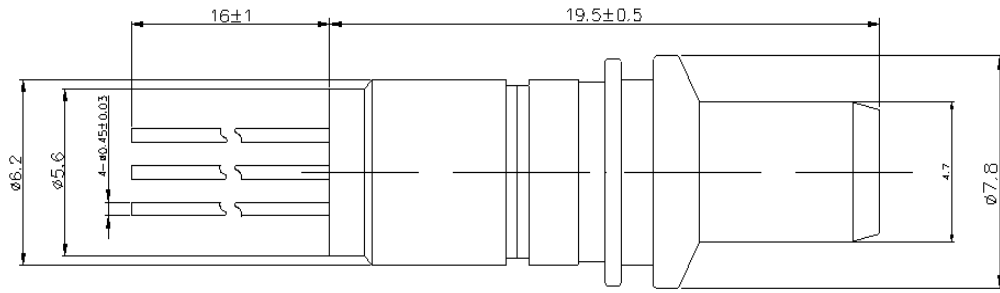
\*Note2: Exceeding any one of these values may destroy the device immediately.

**Electrical and Optical Characteristics:**

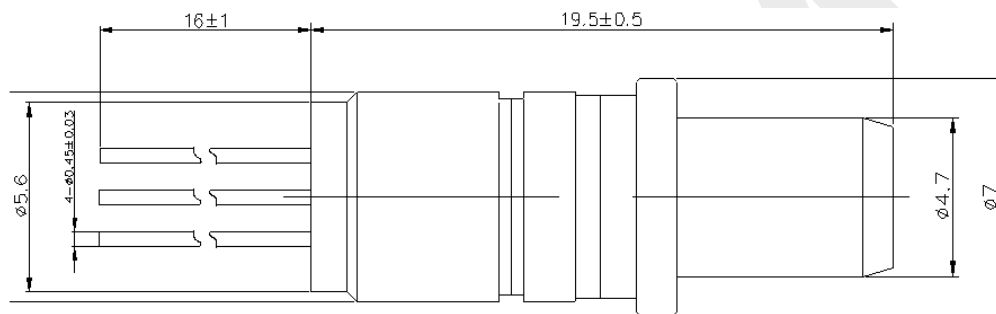
(Pf=1.5mW, SMF (9.5/125μm), Tc=+25°C, unless otherwise noted.)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Threshold Current	Ith	CW	—	8	15	mA
Fiber Coupling Power	Pf	CW, If=Ith+20mA	1	1.5	2.5	mW
Operating Voltage	Vf	CW, Tc=-40~+85°C	—	1.2	1.6	V
Slope Efficiency	Se	CW, Average(Ith to Ith+20mA)	0.05		0.14	mW/mA
Peak Wavelength	λp	CW	1300	1310	1320	nm
		CW, Tc=-40~+85°C	1280		1335	
Side mode suppression ratio	SSR	CW, Tc=-40~+85°C	35	40		dB
Rise Time	tr	Ib=Ith, 20-80%, Tc=-40~+85°C	—		0.05	ns
Fall Time	tf	Ib=Ith, 80-20%, Tc=-40~+85°C	—	0.15	0.05	ns
Tracking Error	ΔPf	Im hold(@Pf=0.16mW(25°C) CW, Tc=-40~+85°C	-1.5	—	1.5	dB
Monitor Current	Im	CW, VrP=5V, Tc=-40~+85°C	100	500	900	uA
Monitor Dark Current	Id	VrP=5V	—	—	10	nA
Monitor Capacitance	C	VrP=5V, f=1MHz	—	10	20	pF
Connector Repeatability	—		-1	—	1	dB
Optical Isolation	—	Single Stage	30			dB
		Dual Stage	40			

**TOSA Package Series:** \*Note3



SC-TOSA5



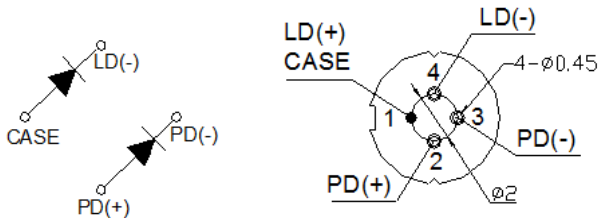
SC-TOSA6

Note3: Laser mark can be customized.

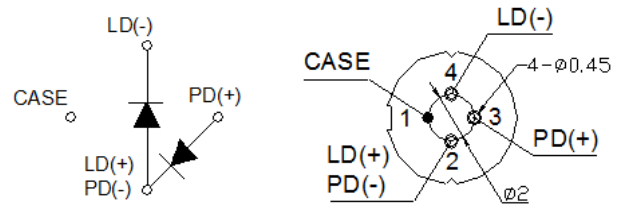
**Pin Assignment:**

TYPE: 1

TYPE: 2



LD-pin-1 / TYPE: C



LD-pin-2 / TYPE: B

**Nomenclature:**

OSMS-TOSA         
 A B C D E F G

No	Parameter	Detailed Description		
A	Split SleeveType	5=TOSA5		6=TOSA6
B	Data Rate	1=1.25G		2=2.5G
C	Pin Type	A=LD-pin-1		B= LD-pin-2
D	LD Type	D=DFB LD		
E	Power	01=0.3-0.8mW	02=0.81-1.8mW	03=1.81-2.5mW
F	Wavelength	3=1310nm		
G	Isolator	Blank=None	G= Single Stage	G2=Dual Stage

**Precaution:**

(1) The modules should be handled in the same manner as ordinary semiconductor devices to prevent the electro-static damages. For safe keeping and carrying, the modules should be packaged with ESD proof material. To assemble the modules on PCB, the workbench, the soldering iron and the human body should be grounded.

(2) Please pay special attention to the atmosphere condition because the dew on the module may cause some electrical damages.

(3) Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

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